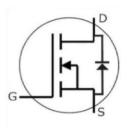


Wolfspeed SiC Gen 3 MOSFET

Description

This is the Wolfspeed's 3rd generation of high performance silicon carbide MOSFET in a packageless bare die format to be implemented into any custom module design. The high blocking voltage with low on-resistance, high speed switching with low capacitance make this MOSFET ideal for high frequency switching application including motor drives and solid state circuit breakers.





Package Types: Bare Die PN's: CPM3-1200-0013A

Features

- 3rd Generation SiC MOSFET
- High blocking voltage with low on-resistance
- High speed switching with low capacitance
- Fast intrinsic diode with low reverse recovery

Applications

- **Motor Drives**
- Solid State Circuit Breakers
- Resonant topologies

Absolute Maximum Ratings

Stress beyond those listed under absolute maximum ratings may damage the device.

Parameter	meter Symbol		Rating	Unit
Drain-Source Voltage, across T _{vj}	V _{DS(max)}		1200	V
Maximum Gate-Source Voltage, Peak Transient Capability	V _{GS(max)}		-8/+19	V
Continuous Drain Current, V _{GS} = 15V, assumes die packaged in	Ip	$T_c = 25$ °C	149	^
TO-247 package with R _{th(j-c)} < 0.28 K/W		$T_c = 100$ °C	102	A
Pulsed Drain Current, t_p limited by $T_{vj(max)}$	I _{D(pulse)}		300	Α
Virtual Junction and Storage Temperature	erature TvJ, Tstg		-55 to 175	°C
Maximum Processing Temperature, in non-reactive ambient	T _{proc}		325	°C

Recommended Operating Conditions

Rev. 03, July 2023

Parameter	Symbol	Rating	Unit
Recommended Operating Gate - Source Voltage	V _{GS(op)}	-4/+15	V

Electrical Characteristics (T_{VJ} = 25°C)

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	V _{(BR)DSS}	1200			V	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$
Gate Threshold Voltage	V _{GS(th)}	1.8	2.5	3.6	V	V _{DS} = V _{GS} , I _{DS} = 27.9 mA
			2		V	V _{DS} = V _{GS} , I _{DS} = 27.9 mA, T _{VJ} = 175°C
Zero Gate Voltage Drain Current	IDSS		1	40	μΑ	V _{DS} = 1200 V, V _{GS} = 0 V
Gate-Source Leakage Current	Igss		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V
Drain-Source On-State Resistance	R _{DS(on)}	9	13	17		V _{GS} = 15 V, I _D = 100 A
			21		mΩ	V _{GS} = 15 V, I _D = 100 A, T _{VJ} = 175°C
Transconductance	gfs		71		- S	V _{DS} = 20 V, I _{DS} = 100 A
			72			V _{DS} = 20 V, I _{DS} = 100 A, T _{VJ} = 175°C
Input Capacitance	Ciss		7560			V =0.V V =1000.V
Output Capacitance	Coss		284		pF	$V_{GS} = 0 \text{ V}, V_{DS} = 1000 \text{ V}$ f = 100 kHz
Reverse Transfer Capacitance	Crss		18			V _{AC} = 25 mV
Coss Stored Energy	E _{oss}		161		μJ	V _{DS} = 1000 V, f = 100 kHz
Internal Gate Resistance	R _{G(int)}		6.7		Ω	f = 1 Mhz, V _{AC} = 25 mV
Gate to Source Charge	Qgs		77			
Gate to Drain Charge	Q _{gd}		95		nC	$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_{DS} = 100 \text{ A}$
Total Gate Charge	Qg		260			

Reverse Diode Characteristics (T_{VJ} = 25 °C)

Characteristics	Symbol	Тур.	Max.	Unit	Test Conditions	
Diode Forward Voltage	VsD	4.6		V	V _{GS} = -4 V, I _{SD} = 50 A	
		4.2		V	$V_{GS} = -4 \text{ V}, I_{SD} = 50 \text{ A}, T_{VJ} = 175 ^{\circ}\text{C}$	
Reverse Recovery Time	trr	43		ns	$V_{GS} = -4 \text{ V}, I_{SD} = 100 \text{ A}, V_R = 800 \text{ V}$ $dif/dt = 3000 \text{ A}/\mu\text{s}, T_{VJ} = 175 \text{ °C}$	
Reverse Recovery Charge	Qrr	1800		nC		
Peak Reverse Recovery Current	Irrm	65		А		

Typical Performance

All the graphs are based on a die placed in a TO-247-4L package.

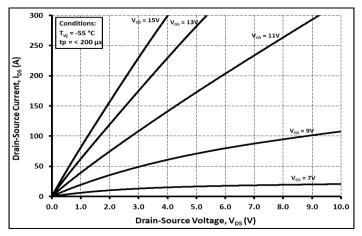


Figure 1.

Output Characteristics $T_{vj} = -55$ °C

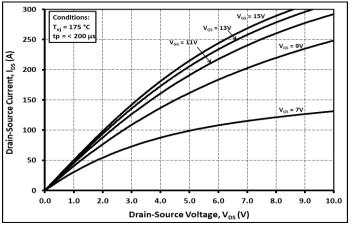


Figure 3.

Output Characteristics T_{vj} = 175 °C

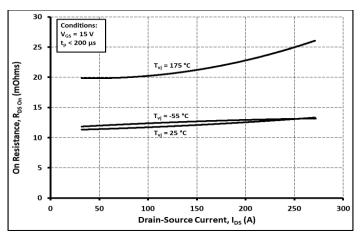


Figure 5.

On-Resistance vs. Drain Current For Various Temperatures

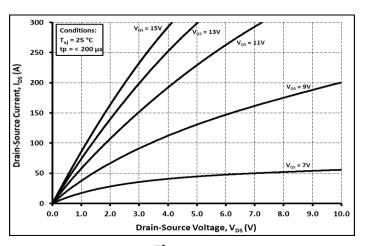


Figure 2.

Output Characteristics T_{vj} = 25 °C

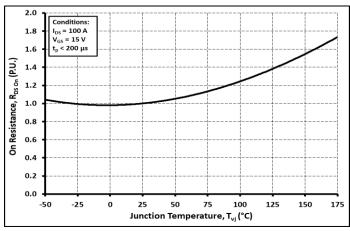


Figure 4.

Normalized On-Resistance vs. Temperature

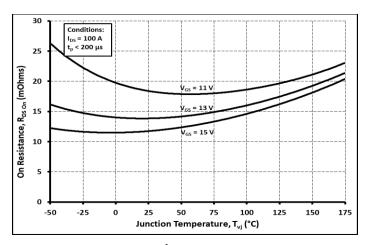


Figure 6.

On-Resistance vs. Temperature For Various Gate Voltages

Typical Performance

All the graphs are based on a die placed in a TO-247-4L package.

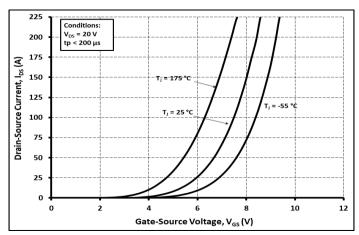


Figure 7.

Transfer Characteristic For Various Junction Temperatures

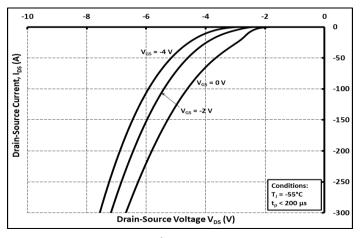


Figure 8.

Body Diode Characteristic at T_{vj} = -55 °C

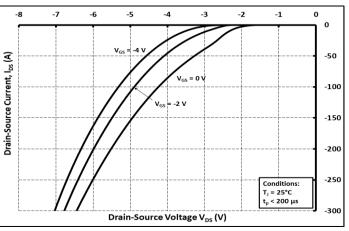
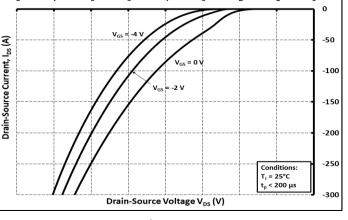


Figure 9.



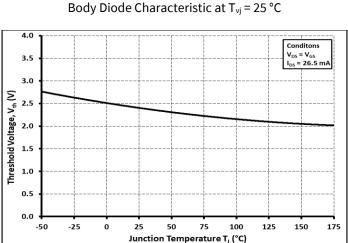


Figure 11.

Threshold Voltage vs. Temperature

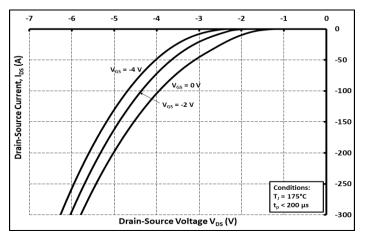


Figure 10.

Body Diode Characteristic at T_{vj} = 175 °C

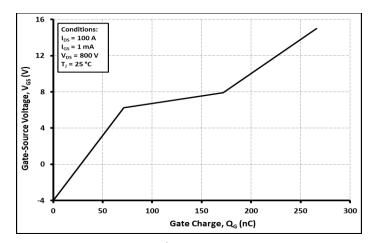


Figure 12.

Gate Charge Characteristics

Typical Performance

All the graphs are based on a die placed in a TO-247-4L package.

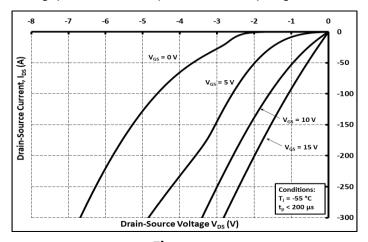


Figure 13.

3rd Quadrant Characteristic at T_{vj} = -55 °C

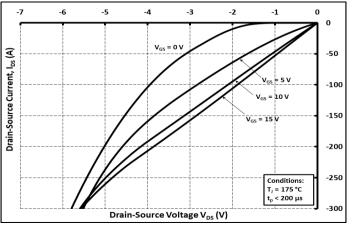


Figure 15.

3rd Quadrant Characteristic at T_{vj} = 175 °C

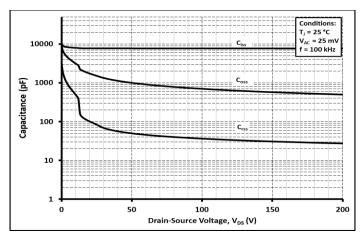


Figure 17.

Capacitances vs. Drain-Source Voltage (0-200V)

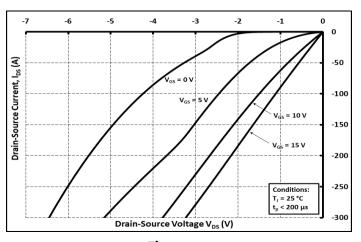


Figure 14.

3rd Quadrant Characteristic at T_{vj} = 25 °C

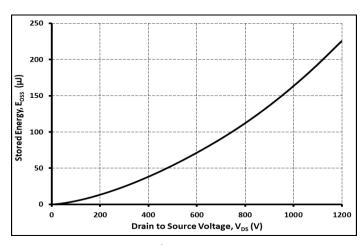


Figure 16.

Output Capacitor Stored Energy

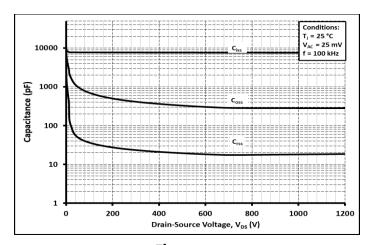


Figure 18.

Capacitances vs. Drain-Source Voltage (0-1200V)

Product Ordering Information

Order Number	Description	Package
CPM3-1200-0013A-FY6	SIC MOSFET G3 IND 1200V/13mO UV MLT	Bare Die Product
CPM3-1200-0013A-GQ8	SIC MOSFET G3 IND 1200V/13mO UV MVF	Bare Die Product

Revision History

Revision History	Date of Change	Brief Summary
-	04/02/2019	Initial Release
1	12/4/2019	 Removed test conditions and note section from the Maximum Ratings Table Updated description for all the parameters in the Maximum Ratings Table Updated footnotes Temperature note removed and embedded into every test condition Updated test conditions for gate threshold voltage, drainsource on-state resistance, transconductance, gate to source charge, gate to drain charge, total gate charge, diode forward voltage, reverse recovery time, reverse recovery charge and peak reverse recovery current Updated typical values for continuous drain current, zero gate voltage drain current, gate-source leakage current, drain-source on-state resistance, transconductance, input capacitance, reverse transfer capacitance, Coss stored energy, gate to source charge, gate to drain charge, total gate charge, reverse recovery time and reverse recovery charge All junction temperatures changed to virtual junction temperatures
2	02/24/2020	 Footnotes updated Mechanical parameters corrected All graphs updated to reflect the most recent test data
3	7/30/2023	Document format updated

Notes & Disclaimer

This document and the information contained herein are subject to change without notice. Any such change shall be evidenced by the publication of an updated version of this document by Wolfspeed. No communication from any employee or agent of Wolfspeed or any third party shall effect an amendment or modification of this document. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

Notwithstanding any application-specific information, guidance, assistance, or support that Wolfspeed may provide, the buyer of this product is solely responsible for determining the suitability of this product for the buyer's purposes, including without limitation for use in the applications identified in the next bullet point, and for the compliance of the buyers' products, including those that incorporate this product, with all applicable legal, regulatory, and safety-related requirements.

This product has not been designed or tested for use in, and is not intended for use in, applications in which failure of the product would reasonably be expected to cause death, personal injury, or property damage, including but not limited to equipment implanted into the human body, life-support machines, cardiac defibrillators, and similar emergency medical equipment, aircraft navigation, communication, and control systems, aircraft power and propulsion systems, air traffic control systems, and equipment used in the planning, construction, maintenance, or operation of nuclear facilities.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.Wolfspeed.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information is also available upon request.

Contact info:

4600 Silicon Drive Durham, NC 27703 USA Tel: +1.919.313.5300 www.wolfspeed.com/power

© 2023 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc. PATENT: https://www.wolfspeed.com/legal/patents

The information in this document is subject to change without notice.